















SNVS090G -MAY 2004-REVISED JUNE 2020

LM341 and LM78M05 Series 3-Terminal 500-mA Positive Voltage Regulators

Features

- For a lower cost alternative, see the UA78M
- Output current in excess of 0.5 A
- No external components
- Internal thermal overload protection
- Internal short circuit current-limiting
- Output transistor safe-area compensation
- Available in 3-pin TO-220, TO-252, and TO packages
- Output voltages of 5 V and 15 V

Applications

- Electronic point-of-sale
- Motor drives
- **Building automation**
- Appliances and white goods
- TVs and set-top boxes

3 Description

The LM341 and LM78M05 three-pin positive voltage regulators employ built-in current limiting, thermal shutdown, and safe-operating area protection, which makes them virtually immune to damage from output overloads.

With adequate heat sinking, they can deliver in excess of 0.5-A output current. Typical applications would include local (on-card) regulators which can eliminate the noise and degraded performance associated with single-point regulation.

Device Information⁽¹⁾

| PART NUMBER | PACKAGE | BODY SIZE (NOM) | | |
|-------------|------------|----------------------|--|--|
| LM341 | TO-220 (3) | 10.16 mm × 14.986 mm | | |
| | TO-220 (3) | 10.16 mm × 14.986 mm | | |
| LM78M05 | TO-252 (3) | 6.10 mm × 6.58 mm | | |
| | TO (3) | 9.14 mm × 9.14 mm | | |

(1) For all available packages, see the orderable addendum at the end of the data sheet.

Available Pinouts



Typical Application

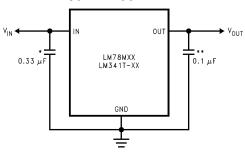




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4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| C | hanges from Revision F (December 2016) to Revision G | | | | |
|---|---|---|--|--|--|
| • | Added lower cost alternative bullet to Features section | 1 | | | |
| • | Changed Applications section | 1 | | | |
| • | Added Device Comparison Table | 3 | | | |
| • | Changed OUTPUT from pin 2 to pin 3 in Pin Functions table | 4 | | | |

Changes from Revision E (August 2005) to Revision F

Page

| • | Added Applications section, Device Information table, Pin Configuration and Functions section, ESD Ratings table, Recommended Operating Conditions table, Thermal Information table, Detailed Description section, Application and Implementation section, Power Supply Recommendations section, Layout section, Device and Documentation Support section, and Mechanical, Packaging, and Orderable Information section |
|---|---|
| • | Deleted parts marked as obsolete: LM78M12 and LM78M15 |
| • | Changed package type names throughout |
| • | Deleted 12-V output voltage option from Features |
| • | Changed R _{θJA} values in <i>Thermal Information</i> table From: 60°C/W To: 22.6°C/W (NDE), From: 92°C/W To: 38°C/W (NDP), and From: 120°C/W To: 162.4°C/W (NDT) |
| • | Changed R _{θJC(top)} values in <i>Thermal Information</i> table From: 5°C/W To: 17.8°C/W (NDE), From: 10°C/W To: 48.4°C/W (NDP), and From: 18°C/W To: 23.9°C/W (NDT) |
| • | Updated Thermal Considerations section |

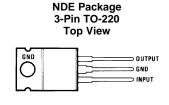


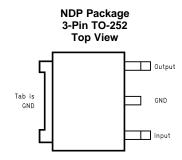
5 Device Comparison Table

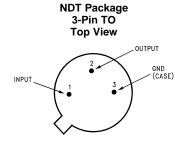
| I _{OUT} | PARAMETER | LM78xx | UA78 | LM340 | LM340A | UNIT |
|------------------|-------------------------------------|---|-------------------------|-----------|-----------|------|
| | Input voltage range | 7 - 35 | 7 - 38 | 7 - 35 | 7 - 35 | V |
| | Fixed output voltage option | 5, 12, 15 | 5, 8, 10, 12, 15, 24 | 5, 12, 15 | 5, 12, 15 | V |
| | Load regulation accuracy | Perange 7 - 35 7 - 38 7 - 35 | % | | | |
| | PSRR (120 Hz) | | dB | | | |
| 1.5 A | Recommended operating temperature | 0 - 125 | 0 - 125 | 0 - 125 | 0 - 125 | °C |
| | TO-220 T _{JA} | 23.9 | 19 | 7 - 38 | °C/W | |
| | SOT-223 T _{JA} | Input voltage range | 62.1 | 62.1 | °C/W | |
| | TO-3 T _{JA} | 39 | N/A | 39 | 39 | °C/W |
| | TO-263 T _{JA} | 44.8 | 25.3 | 44.8 | 44.8 | °C/W |
| | | LM78Mxx | UA78MxxC | UA78MxxI | LM341 | |
| | Input voltage range | 7.2 - 35 | 5.3 - 30 | 5.3 - 30 | 7.2 - 35 | V |
| | Fixed output voltage option | 5 | | 3.3, 5 | 5 | V |
| | Load regulation accuracy | 4 | 3 | 3 | 4 | % |
| | PSRR (120 Hz) | 78 | 80 | 80 | 78 | dB |
| 0.5 A | Recommended operating temperature | -40 - 125 | 0 - 125 | -40 - 125 | -40 - 125 | °C |
| | TO-220 T _{JA} | 22.6 | 19 | 19 | 22.6 | °C/W |
| | SOT-223 T _{JA} | N/A | 53 | 53 | N/A | °C/W |
| | TO-3 T _{JA} | 162.4 | N/A | N/A | N/A | °C/W |
| | TO-252 Powerflex T _{JA} | N/A | 28 | 28 | N/A | °C/W |
| | TO-252 T _{JA} | 38 | 30.3 | 30.3 | N/A | °C/W |
| | | LM78LxxAC | | UA78LxxC | UA78LxxI | |
| | Input voltage range | 7.0 - 30 | 7.0 - 30 | 4.75 - 30 | 4.75 - 30 | V |
| | Fixed output voltage option | 5, 6.2, 12, 15 | 5, 9 | | 5 | V |
| | Load regulation accuracy (A/non -A) | 4 | 4 | 4/8 | 4/8 | % |
| 0.1 A | PSRR (120 Hz) | 62 | 62 | 51 | 51 | dB |
| | Recommended operating temperature | 0 - 125 | -40 - 125 | 0 - 125 | -40 - 125 | °C |
| | SOT-89 T _{JA} | N/A | N/A | 54.7 | 54.7 | °C/W |
| | SO-8 T _{JA} | 128.8 | 128.8 | 115 | 115 | °C/W |
| | DSBGA T _{JA} | N/A | 108.4 | N/A | N/A | °C/W |
| | TO-92 T _{JA} | 158.7 | N/A | 143.6 | 143.6 | °C/W |



6 Pin Configuration and Functions







Pin Functions

| | PIN | | | PIN | | | | |
|--------|-------------------------|-------|---|-----|-------------|--|--|--|
| NAME | NO. TO-220 TO-252 TO | | | I/O | DESCRIPTION | | | |
| NAIVIE | | | | | | | | |
| GND | 2/TAB | 2/TAB | 3 | _ | Tab is GND | | | |
| INPUT | 1 | 1 | 1 | I | Input | | | |
| OUTPUT | 3 | 3 | 2 | 0 | Output | | | |

7 Specifications

7.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)(1)(2)

| | | MIN | MAX | UNIT |
|--|------------------------------|----------|--------------------|------|
| Input voltage | V _O = 5 V to 15 V | | 35 | V |
| Power dissipation | • | Internal | Internally limited | |
| Local to consent one (October on 10 c) | TO package (NDT) | | 300 | 00 |
| Lead temperature (Soldering, 10 s) | TO-220 package (NDE) | | 260 | °C |
| Operating junction temperature | | -40 | 125 | °C |
| Storage temperature, T _{stg} | | -65 | 150 | °C |

- (1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/Distributors for availability and specifications.

7.2 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

| | MIN | MAX | UNIT |
|----------------|------------------------|-----|------|
| Input voltage | V _{OUT} + 1.8 | 35 | V |
| Output current | | 0.5 | Α |



7.3 Thermal Information

| | | LM341 | LM78 | | |
|------------------------|--|--------------|--------------|----------|------|
| | THERMAL METRIC ⁽¹⁾ | NDE (TO-220) | NDP (TO-252) | NDT (TO) | UNIT |
| | | 3 PINS | 3 PINS | 3 PINS | |
| $R_{\theta JA}$ | Junction-to-ambient thermal resistance | 22.6 | 38 | 162.4 | °C/W |
| $R_{\theta JC(top)}$ | Junction-to-case (top) thermal resistance | 17.8 | 48.4 | 23.9 | °C/W |
| $R_{\theta JB}$ | Junction-to-board thermal resistance | 6 | 17.7 | _ | °C/W |
| ΨЈТ | Junction-to-top characterization parameter | 3.3 | 6.7 | _ | °C/W |
| ΨЈВ | Junction-to-board characterization parameter | 6 | 17.9 | _ | °C/W |
| R ₀ JC(bot) | Junction-to-case (bottom) thermal resistance | 1.3 | 4.4 | _ | °C/W |

For more information about traditional and new thermal metrics, see the Semiconductor and IC package thermal metrics application report.

7.4 Electrical Characteristics: LM341 (5 V) and LM78M05

 V_{IN} = 10 V, C_{IN} = 0.33 μ F, C_{O} = 0.1 μ F, T_{J} = 25°C (unless otherwise noted). Limits are specified by production testing or correlation techniques using standard Statistical Quality Control (SQC) methods.

| | PARAMETER | TEST COND | ITIONS | MIN | TYP | MAX | UNIT |
|--------------------|--|--|--|------|-----|------|---------|
| | | I _L = 500 mA | | 4.8 | 5 | 5.2 | |
| Vo | Output voltage | $I_L = 5 \text{ mA to } 500 \text{ mA, } P_D \le V_{IN} = 7.5 \text{ V to } 20 \text{ V, } T_J = -10.0 \text{ mB}$ | 7.5 W, 40°C to 125°C | 4.75 | 5 | 5.25 | V |
| ., | l in a manufation | V 70 V to 05 V | I _L = 100 mA | | | 50 | \/ |
| V _{RLINE} | Line regulation | $V_{IN} = 7.2 \text{ V to } 25 \text{ V}$ | I _L = 500 mA | | | 100 | mV |
| V _{RLOAD} | Load regulation | I _L = 5 mA to 500 mA | I _L = 5 mA to 500 mA | | | 100 | mV |
| IQ | Quiescent current | I _L = 500 mA | | | 4 | 10 | mA |
| 4.1 | Outland at a summent about a | I _L = 5 mA to 500 mA | | | | 0.5 | A |
| ΔI_Q | Quiescent current change | $V_{IN} = 7.5 \text{ V to } 25 \text{ V}, I_L = 50$ | = 500 mA = 5 mA to 500 mA _{IN} = 7.5 V to 25 V, I _L = 500 mA | | | 1 | mA |
| V _n | Output noise voltage | f = 10 Hz to 100 kHz | | | 40 | | μV |
| ΔV_{IN} | Ripple rejection | f = 120 Hz, I _L = 500 mA | | | 78 | | dB |
| V _{IN} | Input voltage required to maintain line regulation | I _L = 500 mA | | 7.2 | | | V |
| ΔV_{O} | Long-term stability | $I_L = 500 \text{ mA}, T_J = -40^{\circ}\text{C to}$ | 125°C | | | 20 | mV/khrs |

7.5 Electrical Characteristics: LM341 (12 V)

 V_{IN} = 19 V, C_{IN} = 0.33 μ F, C_{O} = 0.1 μ F, T_{J} = 25°C (unless otherwise noted). Limits are specified by production testing or correlation techniques using standard Statistical Quality Control (SQC) methods.

| | PARAMETER | TEST CONDIT | TIONS | MIN | TYP | MAX | UNIT |
|--------------------|--|---|-------------------------|------|-----|------|---------|
| | | $I_L = 500 \text{ mA}$ | | 11.5 | 12 | 12.5 | |
| V _O | Output voltage | $I_L = 5$ mA to 500 mA, $P_D \le 7.5$ W, $V_{IN} = 14.8$ V to 27 V, $T_J = -40$ °C to 125°C | | 11.4 | 12 | 12.6 | V |
| ., | Line negation | V 445V4-20V | I _L = 100 mA | | | 120 | \/ |
| V _{RLINE} | Line regulation | $V_{IN} = 14.5 \text{ V to } 30 \text{ V}$ | I _L = 500 mA | | | 240 | mV |
| V_{RLOAD} | Load regulation | I _L = 5 mA to 500 mA | | | | 240 | mV |
| IQ | Quiescent current | I _L = 500 mA | | | 4 | 10 | mA |
| A 1 | | I _L = 5 mA to 500 mA | | | | 0.5 | mA |
| ΔI_Q | Quiescent current change | V _{IN} = 14.8 V to 30 V, I _L = 500 mA | | | | 1 | |
| V _n | Output noise voltage | f = 10 Hz to 100 kHz | | | 75 | | μV |
| ΔV_{IN} | Ripple rejection | f = 120 Hz, I _L = 500 mA | | | 71 | | dB |
| V _{IN} | Input voltage required to maintain line regulation | I _L = 500 mA | | 14.5 | | | V |
| ΔV_{O} | Long-term stability | $I_L = 500 \text{ mA}, T_J = -40^{\circ}\text{C to}$ | 125°C | | | 48 | mV/khrs |



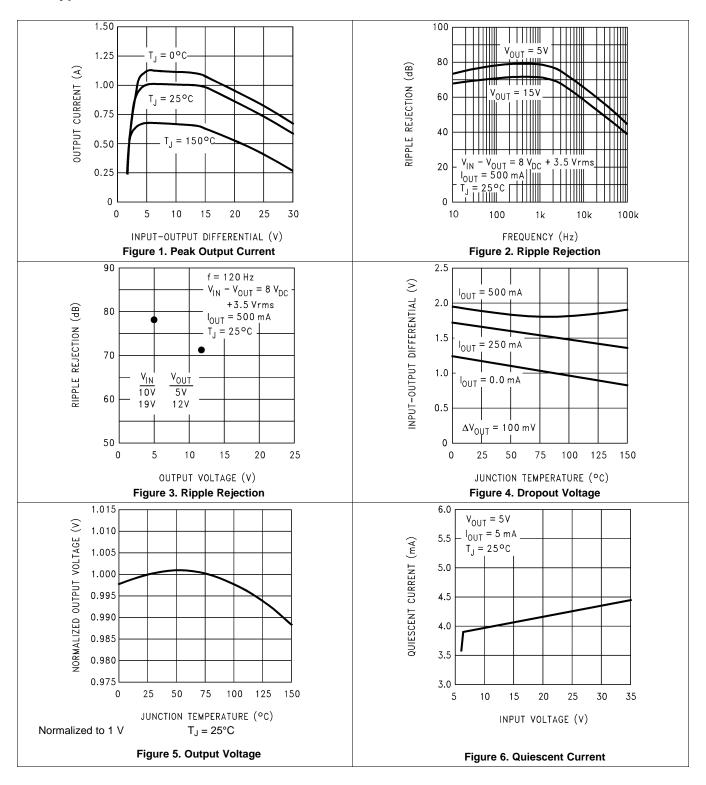
7.6 Electrical Characteristics: LM341 (15 V)

 V_{IN} = 23 V, C_{IN} = 0.33 μ F, C_{O} = 0.1 μ F, T_{J} = 25°C (unless otherwise noted). Limits are specified by production testing or correlation techniques using standard Statistical Quality Control (SQC) methods.

| | PARAMETER | TEST CONDIT | IONS | MIN | TYP | MAX | UNIT |
|--------------------|--|---|-------------------------|------|-------|------|---------|
| | | I _L = 500 mA | | 14.4 | 15 | 15.6 | |
| Vo | Output voltage | $I_{L} = 5 \text{ mA to } 500 \text{ mA}, P_{D} \le 7.5 \text{ W}, V_{IN} = 18 \text{ V}$ $to 30 \text{ V}, T_{J} = -40^{\circ}\text{C to } 125^{\circ}\text{C}$ $V_{IN} = 17.6 \text{ V to } 30 \text{ V}$ $I_{L} = 100 \text{ mA}$ $I_{L} = 5 \text{ mA to } 500 \text{ mA}$ $I_{L} = 500 \text{ mA}$ $I_{L} = 5 \text{ mA to } 500 \text{ mA}$ $I_{L} = 5 \text{ mA to } 500 \text{ mA}$ $V_{IN} = 18 \text{ V to } 30 \text{ V}, I_{L} = 500 \text{ mA}$ $f = 10 \text{ Hz to } 100 \text{ kHz}$ $f = 120 \text{ Hz}, I_{L} = 500 \text{ mA}$ | 14.25 | 15 | 15.75 | V | |
| ., | Line regulation | \/ 47.6\/ to 20\/ | I _L = 100 mA | | | 150 | m\/ |
| V _{RLINE} | Line regulation | $V_{IN} = 17.6 \text{ V to 30 V}$ | I _L = 500 mA | | | 300 | mV |
| V_{RLOAD} | Load regulation | I _L = 5 mA to 500 mA | | | | 300 | mV |
| IQ | Quiescent current | I _L = 500 mA | | | 4 | 10 | mA |
| 4.1 | Outlinease to summent the same | I _L = 5 mA to 500 mA | | | | 0.5 | Л |
| ΔI_Q | Quiescent current change | $V_{IN} = 18 \text{ V to } 30 \text{ V}, I_{L} = 500$ | mA | | | 1 | mA |
| V _n | Output noise voltage | f = 10 Hz to 100 kHz | | | 90 | | μV |
| ΔV_{IN} | Ripple rejection | f = 120 Hz, I _L = 500 mA | | | 69 | | dB |
| V _{IN} | Input voltage required to maintain line regulation | I _L = 500 mA | | 17.6 | | | V |
| ΔV_{O} | Long-term stability | $I_L = 500 \text{ mA}, T_J = -40^{\circ}\text{C to}$ | 125°C | | | 60 | mV/khrs |

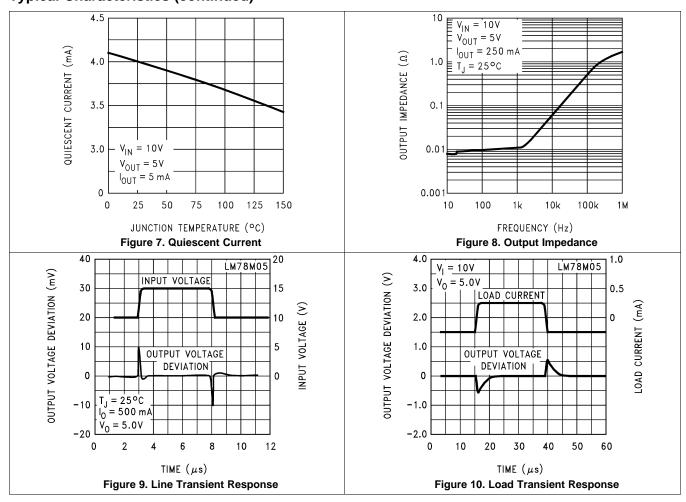


7.7 Typical Characteristics





Typical Characteristics (continued)



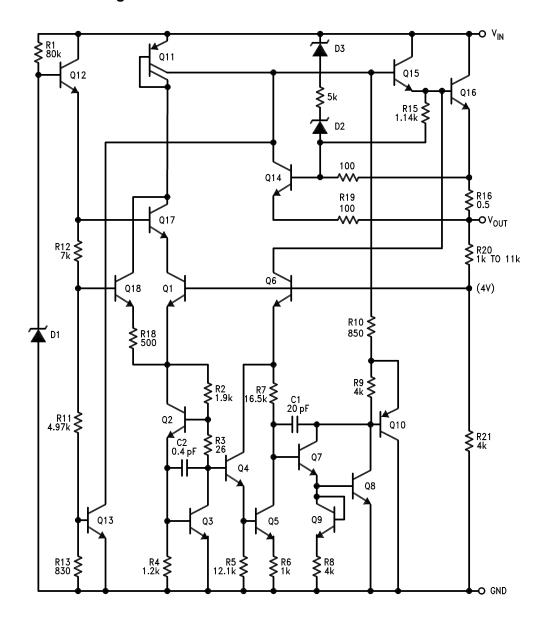


8 Detailed Description

8.1 Overview

The LM341 and LM78M05 devices are a family of fixed positive voltage regulators. They can accept up to 35 V at the input and regulate it down to outputs of 5 V, 12 V, or 15 V. The devices are capable of supplying up to 500 mA of output current, although it is important to ensure there is adequate heat sinking to avoid exceeding thermal limits. However, in the case of accidental overload the device has built in current limiting, thermal shutdown and safe-operating area protection to prevent damage from occurring.

8.2 Functional Block Diagram



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8.3 Feature Description

The LM341 and LM78M05 fixed voltage regulators have built-in thermal overload protection which prevents the device from being damaged due to excessive junction temperature.

The regulators also contain internal short-circuit protection which limits the maximum output current, and safearea protection for the pass transistor which reduces the short-circuit current as the voltage across the pass transistor is increased.

Although the internal power dissipation is automatically limited, the maximum junction temperature of the device must be kept below 125°C to meet data sheet specifications. An adequate heat sink must be provided to assure this limit is not exceeded under worst-case operating conditions (maximum input voltage and load current) if reliable performance is to be obtained.

8.4 Device Functional Modes

8.4.1 Normal Operation

The device OUTPUT pin sources current necessary to make the voltage at the OUTPUT pin equal to the fixed voltage level of the device.

8.4.2 Operation With Low Input Voltage

The device requires up to 2-V headroom $(V_I - V_O)$ to operate in regulation. With less headroom, the device may drop out of regulation in which the OUTPUT voltage would equal INPUT voltage minus dropout voltage.

8.4.3 Operation in Self Protection

When an overload occurs, the device shuts down Darlington NPN output stage or reduce the output current to prevent device damage. The device automatically resets from the overload. The output may be reduced or alternate between on and off until the overload is removed.



9 Application and Implementation

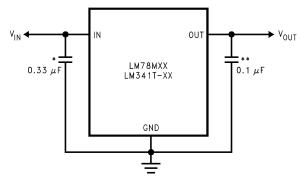
NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

9.1 Application Information

The LM341 and LM78Mxx devices are fixed voltage regulators meaning no external feedback resistors are required to set the output voltage. Input and output capacitors are also not required for the device to be stable. However input capacitance helps filter noise from the supply and output capacitance improves the transient response.

9.2 Typical Application



^{*}Required if regulator input is more than 4 inches from input filter capacitor (or if no input filter capacitor is used).

Figure 11. Typical Application

9.2.1 Design Requirements

For this design example, use the parameters listed in Table 1 as the input parameters.

Table 1. Design Parameters

| PARAMETER | VALUE |
|------------------|---------|
| C _{IN} | 0.33 μF |
| C _{OUT} | 0.1 μF |

9.2.2 Detailed Design Procedure

9.2.2.1 Input Voltage

Regardless of the output voltage option being used (5 V, 12 V, 15 V), the input voltage must be at least 2 V greater to ensure proper regulation (7 V, 14 V, 17 V).

9.2.2.2 Output Current

Depending on the input-output voltage differential, the output current must be limited to ensure maximum power dissipation is not exceeded. The graph in Figure 1 shows the appropriate current limit for a variety of conditions.

9.2.2.3 Input Capacitor

If no power supply filter capacitor is used or if the device is placed more than four inches away from the capacitor of the power supply, an additional capacitor placed at the input pin of the device helps bypass noise.

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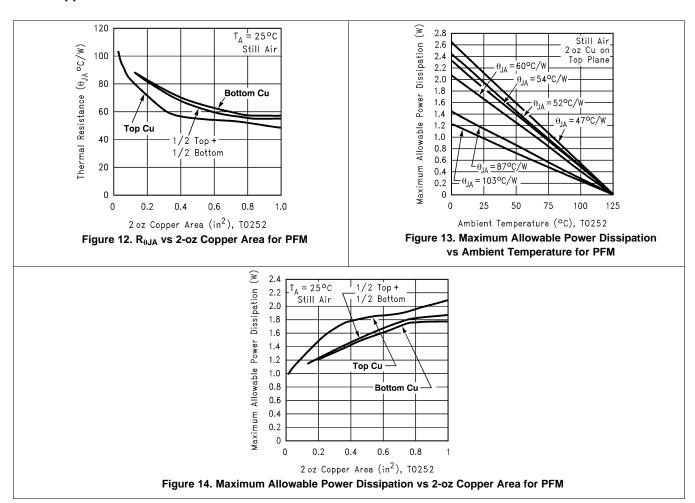
^{**}Optional for improved transient response.



9.2.2.4 Output Capacitor

These devices are designed to be stable with no output capacitance and can be omitted from the design if needed. However if large changes in load are expected, an output capacitor is recommended to improve the transient response.

9.2.3 Application Curves



10 Power Supply Recommendations

The LM341 and LM78M05 devices are designed to operate from an input voltage supply range between $V_{OUT} + 2 \text{ V}$ to 35 V. If the device is more than four inches from the power supply filter capacitors, an input bypass capacitor 0.1- μ F or greater of any type is recommended.

11 Layout

11.1 Layout Guidelines

Some layout guidelines must be followed to ensure proper regulation of the output voltage with minimum noise. TI recommends that the input terminal be bypassed to ground with a bypass capacitor. The optimum placement is closest to the input terminal of the device and the system GND. Take care to minimize the loop area formed by the bypass-capacitor connection, the input terminal, and the system GND. Traces carrying the load current must be wide to reduce the amount of parasitic trace inductance. In cases when VIN shorts to ground, an external diode must be placed from VOUT to VIN to divert the surge current from the output capacitor and protect the IC. This diode must be placed close to the corresponding IC pins to increase their effectiveness.



Layout Guidelines (continued)

11.1.1 Thermal Considerations

When an integrated circuit operates with appreciable current, its junction temperature is elevated. It is important to quantify its thermal limits to achieve acceptable performance and reliability. This limit is determined by summing the individual parts consisting of a series of temperature rises from the semiconductor junction to the operating environment. A one-dimension steady-state model of conduction heat transfer is demonstrated in Figure 15. The heat generated at the device junction flows through the die to the die attach pad, through the lead frame to the surrounding case material, to the printed-circuit board, and eventually to the ambient environment.

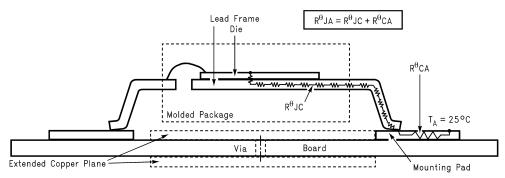
There are several variables that may affect the thermal resistance and in turn the need for a heat sink, which includes the following.

Component variables (R_{0JC})

- · Leadframe size and material
- Number of conduction pins
- Die size
- Die attach material
- Molding compound size and material

Application variables (R_{θCA})

- Mounting pad size, material, and location
- · Placement of mounting pad
- · PCB size and material
- Traces length and width
- · Adjacent heat sources
- Volume of air
- Ambient temperature
- Shape of mounting pad



The case temperature is measured at the point where the leads contact the mounting pad surface

Figure 15. Cross-Sectional View of Integrated Circuit Mounted on a Printed-Circuit Board

The LM341 and LM78M05 regulators have internal thermal shutdown to protect the device from overheating. Under all possible operating conditions, the junction temperature of the LM341 and LM78M05 must be within the range of 0° C to 125° C. A heat sink may be required depending on the maximum power dissipation and maximum ambient temperature of the application. To determine if a heat sink is needed, the power dissipated by the regulator (P_D) is calculated using Equation 1.

$$I_{IN} = I_L + I_G \tag{1}$$

$$P_{D} = (V_{IN} - V_{OUT}) \times I_{L} + (V_{IN} \times I_{G})$$

$$(2)$$



Layout Guidelines (continued)

Figure 16 shows the voltages and currents which are present in the circuit.

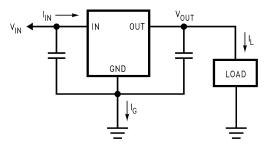


Figure 16. Power Dissipation Diagram

The next parameter which must be calculated is the maximum allowable temperature rise, T_{R(MAX)}.

$$T_{R(MAX)} = T_{J(MAX)} - T_{A(MAX)}$$

where

- T_{J(MAX)} is the maximum allowable junction temperature (125°C)
- T_{A(MAX)} is the maximum ambient temperature encountered in the application

Using the calculated values for $T_{R(MAX)}$ and P_D , the maximum allowable value for the junction-to-ambient thermal resistance ($R_{\theta JA}$) can be calculated with Equation 3.

$$R_{\theta JA} = T_{R(MAX)} / P_{D}$$
 (3)

As a design aid, Table 2 lists the value of the $R_{\theta JA}$ of TO-252 for different heat sink area. The copper patterns that we used to measure these $R_{\theta JA}$ are shown at the end of the *AN-1028 Maximum Power Enhancement Techniques for Power Packages* application note. Figure 12 reflects the same test results as what are in the Table 2.

Figure 13 illustrates the maximum allowable power dissipation versus ambient temperature for the PFM device. Figure 14 illustrates the maximum allowable power dissipation versus copper area (in²) for the TO-252 device. For power enhancement techniques to be used with TO-252 package, see the *AN-1028 Maximum Power Enhancement Techniques for Power Packages* application note.



Layout Guidelines (continued)

Table 2. $R_{\theta JA}$ Different Heat Sink Area

| LAYOUT | COPPER | THERMAL RESISTANCE: R _{θJA} (°C/W) | |
|--------|-------------|---|--------|
| | TOP SIDE(1) | BOTTOM SIDE | TO-252 |
| 1 | 0.0123 | 0 | 103 |
| 2 | 0.066 | 0 | 87 |
| 3 | 0.3 | 0 | 60 |
| 4 | 0.53 | 0 | 54 |
| 5 | 0.76 | 0 | 52 |
| 6 | 1 | 0 | 47 |
| 7 | 0 | 0.2 | 84 |
| 8 | 0 | 0.4 | 70 |
| 9 | 0 | 0.6 | 63 |
| 10 | 0 | 0.8 | 57 |
| 11 | 0 | 1 | 57 |
| 12 | 0.066 | 0.066 | 89 |
| 13 | 0.175 | 0.175 | 72 |
| 14 | 0.284 | 0.284 | 61 |
| 15 | 0.392 | 0.392 | 55 |
| 16 | 0.5 | 0.5 | 53 |

⁽¹⁾ Tab of device is attached to topside copper.

11.2 Layout Example

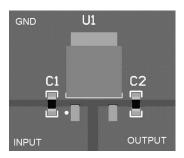


Figure 17. Layout Recommendation



12 Device and Documentation Support

12.1 Documentation Support

12.1.1 Related Documentation

For related documentation see the following:

Texas Instruments, AN-1028 Maximum Power Enhancement Techniques for Power Packages application note

12.2 Related Links

The table below lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to order now.

Table 3. Related Links

| PARTS | PRODUCT FOLDER | ORDER NOW | TECHNICAL DOCUMENTS | TOOLS & SOFTWARE | SUPPORT & COMMUNITY |
|---------|----------------|------------|---------------------|------------------|---------------------|
| LM341 | Click here | Click here | Click here | Click here | Click here |
| LM78M05 | Click here | Click here | Click here | Click here | Click here |

12.3 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

12.4 Support Resources

TI E2E™ support forums are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

12.5 Trademarks

E2E is a trademark of Texas Instruments.

All other trademarks are the property of their respective owners.

12.6 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

12.7 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



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PACKAGING INFORMATION

| Orderable Device | Status | Package Type | Package Drawing | Pins | Package Qty | Eco Plan | Lead finish/ Ball material | MSL Peak Temp | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|---------|--------------|--------------------|------|----------------|---------------------|-------------------------------|---------------------|--------------|-------------------------|---------|
| LM341T-15/NOPB | ACTIVE | TO-220 | NDE | 3 | 45 | RoHS & Green | SN | Level-1-NA-UNLIM | -40 to 125 | LM341T-15 LM78M15CT | Samples |
| LM341T-5.0 | LIFEBUY | TO-220 | NDE | 3 | 45 | Non-RoHS & Green | Call TI | Level-1-NA-UNLIM | -40 to 125 | LM341T-5.0 LM78M05CT | |
| LM341T-5.0/NOPB | ACTIVE | TO-220 | NDE | 3 | 45 | RoHS & Green | SN | Level-1-NA-UNLIM | -40 to 125 | LM341T-5.0 LM78M05CT | Samples |
| LM78M05CDT | LIFEBUY | TO-252 | NDP | 3 | 75 | Non-RoHS & Green | Call TI | Level-1-235C-UNLIM | -40 to 125 | LM78M05 CDT | |
| LM78M05CDT/NOPB | ACTIVE | TO-252 | NDP | 3 | 75 | RoHS & Green | SN | Level-2-260C-1 YEAR | -40 to 125 | LM78M05 CDT | Samples |
| LM78M05CDTX | LIFEBUY | TO-252 | NDP | 3 | 2500 | Non-RoHS & Green | Call TI | Level-1-235C-UNLIM | -40 to 125 | LM78M05 CDT | |
| LM78M05CDTX/NOPB | ACTIVE | TO-252 | NDP | 3 | 2500 | RoHS & Green | SN | Level-2-260C-1 YEAR | -40 to 125 | LM78M05 CDT | Samples |
| LM78M05CT | LIFEBUY | TO-220 | NDE | 3 | 45 | Non-RoHS & Green | Call TI | Level-1-NA-UNLIM | -40 to 125 | LM341T-5.0 LM78M05CT | |
| LM78M05CT/NOPB | ACTIVE | TO-220 | NDE | 3 | 45 | RoHS & Green | SN | Level-1-NA-UNLIM | -40 to 125 | LM341T-5.0 LM78M05CT | Samples |
| LM78M15CT/NOPB | ACTIVE | TO-220 | NDE | 3 | 45 | RoHS & Green | SN | Level-1-NA-UNLIM | -40 to 125 | LM341T-15 LM78M15CT | Samples |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽²⁾ **RoHS**: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".



PACKAGE OPTION ADDENDUM

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- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





| A0 | Dimension designed to accommodate the component width |
|----|---|
| В0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------------|-----------------|--------------------|---|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| LM78M05CDTX | TO-252 | NDP | 3 | 2500 | 330.0 | 16.4 | 6.9 | 10.5 | 2.7 | 8.0 | 16.0 | Q2 |
| LM78M05CDTX/NOPB | TO-252 | NDP | 3 | 2500 | 330.0 | 16.4 | 6.9 | 10.5 | 2.7 | 8.0 | 16.0 | Q2 |

PACKAGE MATERIALS INFORMATION

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*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| LM78M05CDTX | TO-252 | NDP | 3 | 2500 | 367.0 | 367.0 | 35.0 |
| LM78M05CDTX/NOPB | TO-252 | NDP | 3 | 2500 | 356.0 | 356.0 | 35.0 |

PACKAGE MATERIALS INFORMATION

www.ti.com 23-Jun-2023

TUBE



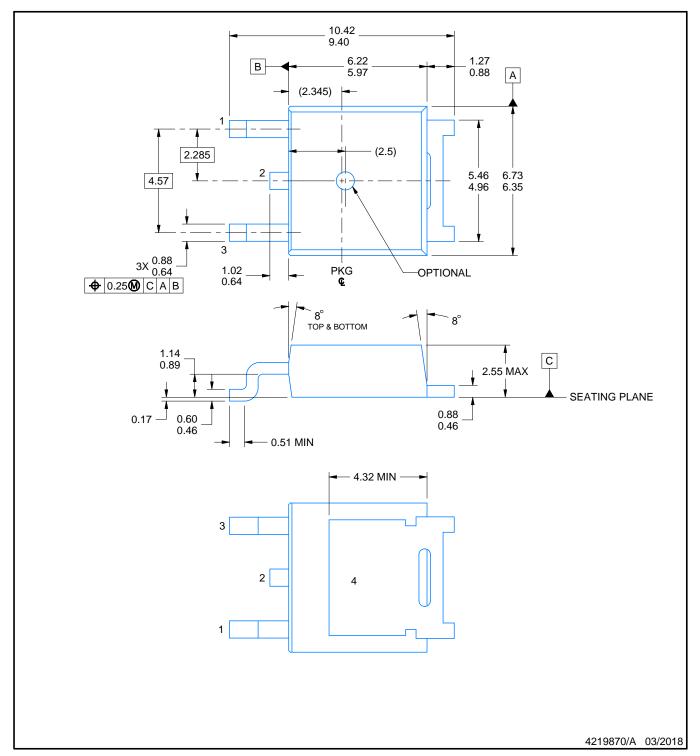
*All dimensions are nominal

| Device | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (µm) | B (mm) |
|-----------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| LM341T-15/NOPB | NDE | TO-220 | 3 | 45 | 502 | 33 | 6985 | 4.06 |
| LM341T-5.0 | NDE | TO-220 | 3 | 45 | 502 | 33 | 6985 | 4.06 |
| LM341T-5.0 | NDE | TO-220 | 3 | 45 | 502 | 33 | 6985 | 4.06 |
| LM341T-5.0/NOPB | NDE | TO-220 | 3 | 45 | 502 | 33 | 6985 | 4.06 |
| LM78M05CDT | NDP | TO-252 | 3 | 75 | 508 | 20 | 4165.6 | 3.1 |
| LM78M05CDT | NDP | TO-252 | 3 | 75 | 508 | 20 | 4165.6 | 3.1 |
| LM78M05CDT/NOPB | NDP | TO-252 | 3 | 75 | 508 | 20 | 4165.6 | 3.1 |
| LM78M05CT | NDE | TO-220 | 3 | 45 | 502 | 33 | 6985 | 4.06 |
| LM78M05CT | NDE | TO-220 | 3 | 45 | 502 | 33 | 6985 | 4.06 |
| LM78M05CT/NOPB | NDE | TO-220 | 3 | 45 | 502 | 33 | 6985 | 4.06 |
| LM78M15CT/NOPB | NDE | TO-220 | 3 | 45 | 502 | 33 | 6985 | 4.06 |





TRANSISTOR OUTLINE



NOTES:

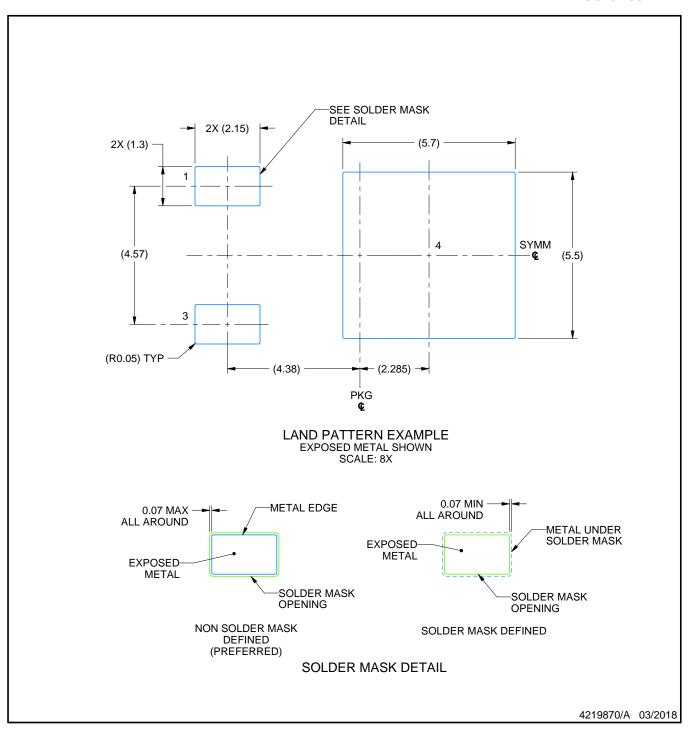
- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

 2. This drawing is subject to change without notice.

 3. Reference JEDEC registration TO-252.



TRANSISTOR OUTLINE

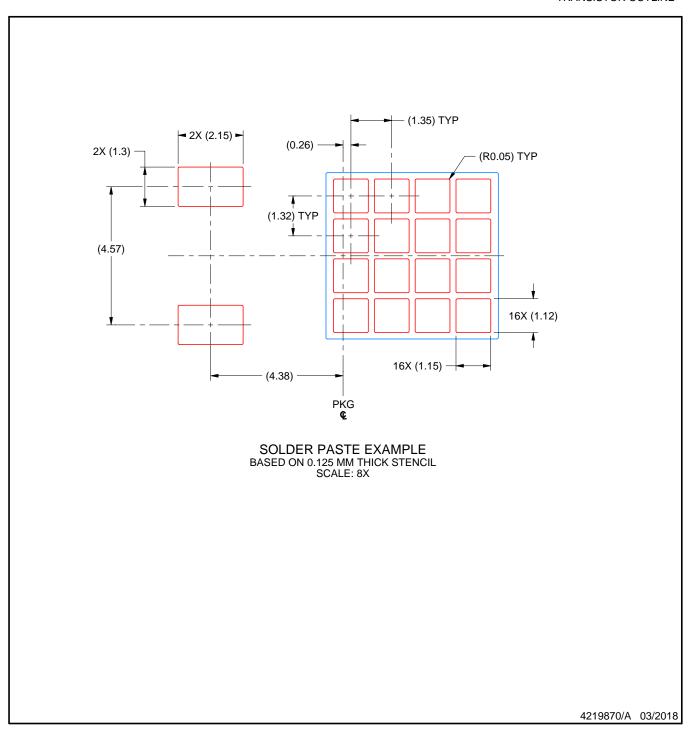


NOTES: (continued)

- 4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature numbers SLMA002(www.ti.com/lit/slm002) and SLMA004 (www.ti.com/lit/slma004).
- 5. Vias are optional depending on application, refer to device data sheet. It is recommended that vias under paste be filled, plugged or tented.



TRANSISTOR OUTLINE



NOTES: (continued)



^{6.} Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

7. Board assembly site may have different recommendations for stencil design.

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